

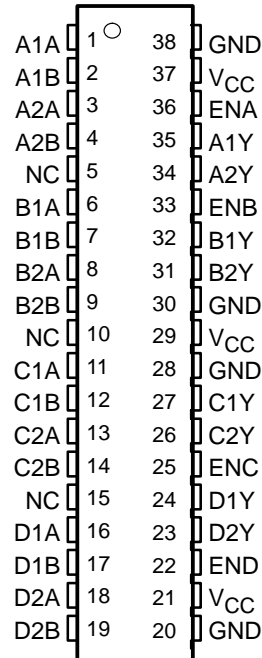
# SN65LVDS388, SN65LVDT388, SN75LVDS388, SN75LVDT388 HIGH-SPEED DIFFERENTIAL LINE RECEIVERS

SLLS448A – SEPTEMBER 2000 – REVISED MAY 2001

- Eight Line Receivers Meet or Exceed the Requirements of ANSI TIA/EIA-644 Standard
- Integrated 110-Ω Line Termination Resistors on LVDT Products
- Designed for Signaling Rates† Up To 630 Mbps
- SN65 Version's Bus-Terminal ESD Exceeds 15 kV
- Operates From a Single 3.3-V Supply
- Propagation Delay Time of 2.6 ns (Typ)
- Output Skew 100 ps (Typ)  
Part-To-Part Skew Is Less Than 1 ns
- LVTTTL Levels Are 5-V Tolerant
- Open-Circuit Fail Safe
- Flow-Through Pin Out
- Packaged in Thin Shrink Small-Outline Package With 20-mil Terminal Pitch

**NOT RECOMMENDED FOR NEW DESIGNS  
For Replacement Use 'LVDx388A**

'LVDS388, 'LVDT388  
DBT PACKAGE  
(TOP VIEW)

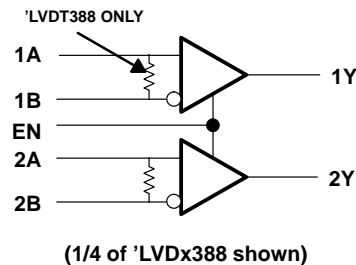


## description

The 'LVDS388 and 'LVDT388 (*T* designates integrated termination) are eight differential line receivers that implement the electrical characteristics of low-voltage differential signaling (LVDS). This signaling technique lowers the output voltage levels of 5-V differential standard levels (such as EIA/TIA-422B) to reduce the power, increase the switching speeds, and allow operation with a 3-V supply rail. Any of the eight differential receivers will provide a valid logical output state with a  $\pm 100$ -mV differential input voltage within the input common-mode voltage range. The input common-mode voltage range allows 1 V of ground potential difference between two LVDS nodes. Additionally, the high-speed switching of LVDS signals always require the use of a line impedance matching resistor at the receiving end of the cable or transmission media. The LVDT product eliminates this external resistor by integrating it with the receiver.

## logic diagram (positive logic)

'LVDx388



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

† Signaling rate, 1/t, where t is the minimum unit interval and is expressed in the units bits/s (bits per second)

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS  
INSTRUMENTS**

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# SN65LVDS388, SN65LVDT388, SN75LVDS388, SN75LVDT388

## HIGH-SPEED DIFFERENTIAL LINE RECEIVERS

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### description (continued)

The intended application of this device and signaling technique is for point-to-point baseband data transmission over controlled impedance media of approximately 100 Ω. The transmission media may be printed-circuit board traces, backplanes, or cables. The large number of drivers integrated into the same substrate along with the low pulse skew of balanced signaling, allows extremely precise timing alignment of clock and data for synchronous parallel data transfers. When used with its companion, 8-channel driver, the SN65LVDS389 over 150 million data transfers per second in single-edge clocked systems are possible with very little power. Note: The ultimate rate and distance of data transfer is dependent upon the attenuation characteristics of the media, the noise coupling to the environment, and other system characteristics.

The SN65LVDS388 and SN65LVDT388 is characterized for operation from -40°C to 85°C. The SN75LVDS388 and SN75LVDT388 is characterized for operation from 0°C to 70°C.

#### AVAILABLE OPTIONS

PART NUMBER	TEMPERATURE RANGE	NUMBER OF RECEIVERS	BUS-PIN ESD
SN65LVDS388DBT	-40°C to 85°C	8	15 kV
SN65LVDT388DBT	-40°C to 85°C	8	15 kV
SN75LVDS388DBT	0°C to 70°C	8	4 kV
SN75LVDT388DBT	0°C to 70°C	8	4 kV

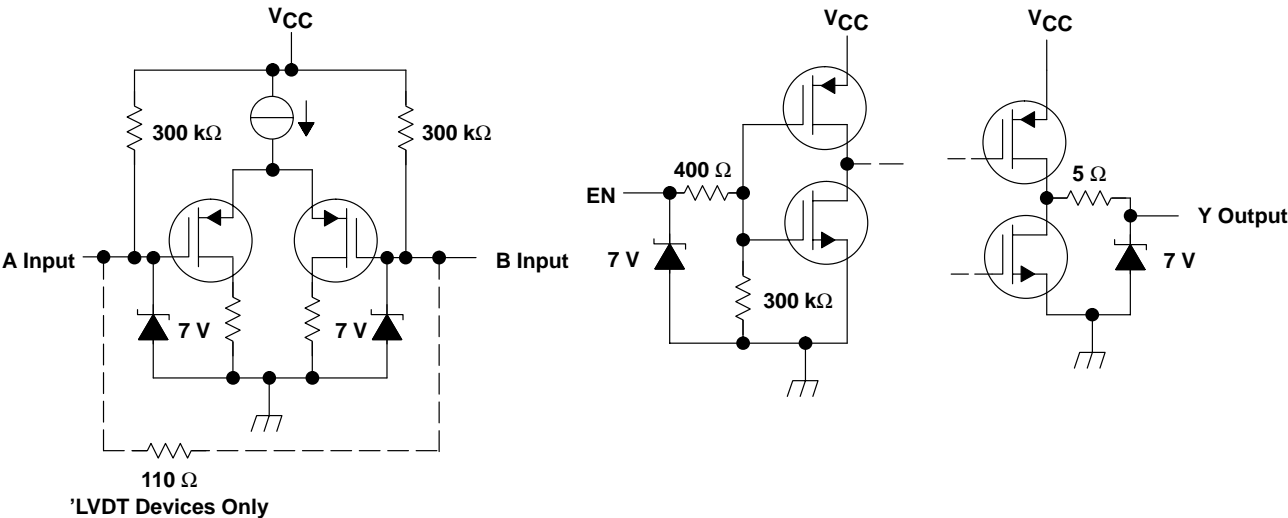
#### Function Table

SNx5LVD388 and SNx5LVDT388

DIFFERENTIAL INPUT	ENABLES	OUTPUT
A-B	EN	Y
$V_{ID} \geq 100 \text{ mV}$	H	H
$-100 \text{ mV} < V_{ID} \leq 100 \text{ mV}$	H	?
$V_{ID} \leq -100 \text{ mV}$	H	L
X	L	Z
Open	H	H

H = high level, L = low level, X = irrelevant,  
Z = high impedance (off), ? = indeterminate

### equivalent input and output schematic diagrams



# SN65LVDS388, SN65LVDT388, SN75LVDS388, SN75LVDT388 HIGH-SPEED DIFFERENTIAL LINE RECEIVERS

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## absolute maximum ratings over operating free-air temperature (unless otherwise noted)<sup>†</sup>

Supply voltage range, $V_{CC}$ (see Note 1)	–0.5 V to 4 V
Voltage range: Enables or Y	–0.5 V to 6 V
A or B	–0.5 V to 4 V
Electrostatic discharge: (see Note 2)	
SN65' (A, B, and GND)	Class 3, A:15 kV, B: 700 V
SN75' (A, B, and GND)	Class 2, A:4 kV, B: 400 V
Continuous power dissipation	See Dissipation Rating Table
Storage temperature range	–65°C to 150°C
Lead temperature 1,6 mm (1/16 in) from case for 10 seconds	260°C

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values, except differential I/O bus voltages, are with respect to network ground terminal.  
2. Tested in accordance with MIL-STD-883C Method 3015.7.

DISSIPATION RATING TABLE

PACKAGE	$T_A \leq 25^\circ\text{C}$	DERATING FACTOR <sup>‡</sup> ABOVE $T_A = 25^\circ\text{C}$	$T_A = 70^\circ\text{C}$ POWER RATING	$T_A = 85^\circ\text{C}$ POWER RATING
DBT	1071 mW	8.5 mW/°C	688 mW	556 mW

<sup>‡</sup> This is the inverse of the junction-to-ambient thermal resistance when board-mounted (low-k) and with no air flow.

## recommended operating conditions

		MIN	NOM	MAX	UNIT
Supply voltage, $V_{CC}$		3	3.3	3.6	V
High-level input voltage, $V_{IH}$	Enables	2			V
Low-level input voltage, $V_{IL}$	Enables			0.8	V
Magnitude of differential input voltage, $ V_{ID} $		0.1		0.6	V
Common-mode input voltage, $V_{IC}$ (see Figure 4)		$\frac{ V_{ID} }{2}$	$2.4 - \frac{ V_{ID} }{2}$	$V_{CC} - 0.8$	V
Operating free-air temperature, $T_A$	SN75'	0		70	°C
	SN65'	–40		85	°C



# SN65LVDS388, SN65LVDT388, SN75LVDS388, SN75LVDT388 HIGH-SPEED DIFFERENTIAL LINE RECEIVERS

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## electrical characteristics over recommended operating conditions (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP†	MAX	UNIT
V <sub>IT+</sub>	Positive-going differential input voltage threshold	See Figure 1 and Table 1			100	mV
V <sub>IT-</sub>	Negative-going differential input voltage threshold		-100			mV
V <sub>OH</sub>	High-level output voltage	I <sub>OH</sub> = -8 mA	2.4	3		V
V <sub>OL</sub>	Low-level output voltage	I <sub>OL</sub> = 8 mA		0.2	0.4	V
I <sub>CC</sub>	Supply current	Enabled, No load		50	70	mA
		Disabled			3	mA
I <sub>I</sub>	'LVDS	V <sub>I</sub> = 0 V		-13	-20	μA
		V <sub>I</sub> = 2.4 V	-1.2	-3		
	'LVDT	V <sub>I</sub> = 0 V, other input open			-40	
		V <sub>I</sub> = 2.4 V, other input open	-2.4			
I <sub>ID</sub>	Differential input current  I <sub>IA</sub> - I <sub>IB</sub>	'LVDS V <sub>IA</sub> = 0 V, V <sub>IB</sub> = 0.1 V, V <sub>IA</sub> = 2.4 V, V <sub>IB</sub> = 2.3 V			±2	μA
I <sub>ID</sub>	Differential input current (I <sub>IA</sub> - I <sub>IB</sub> )	'LVDT V <sub>IA</sub> = 0.2 V, V <sub>IB</sub> = 0 V, V <sub>IA</sub> = 2.4 V, V <sub>IB</sub> = 2.2 V	1.5		2.2	mA
I <sub>I(OFF)</sub>	Power-off input current (A or B inputs)	'LVDS V <sub>CC</sub> = 0 V, V <sub>I</sub> = 2.4 V		12	±20	μA
I <sub>I(OFF)</sub>	Power-off input current (A or B inputs)	'LVDT V <sub>CC</sub> = 0 V, V <sub>I</sub> = 2.4 V			±40	μA
I <sub>IH</sub>	High-level input current (enables)	V <sub>IH</sub> = 2 V			10	μA
I <sub>IL</sub>	Low-level input current (enables)	V <sub>IL</sub> = 0.8 V			10	μA
I <sub>OZ</sub>	High-impedance output current	V <sub>O</sub> = 0 V			±1	μA
		V <sub>O</sub> = 3.6 V			10	
C <sub>IN</sub>	Input capacitance, A or B input to GND	V <sub>ID</sub> = 0.4 sin 2.5E09 t V		5		pF
Z <sub>(t)</sub>	Termination impedance	V <sub>ID</sub> = 0.4 sin 2.5E09 t V	88		132	Ω

† All typical values are at 25°C and with a 3.3-V supply.

## switching characteristics over recommended operating conditions (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP†	MAX	UNIT
t <sub>PLH</sub>	Propagation delay time, low-to-high-level output	See Figure 2	1	2.6	4	ns
t <sub>PHL</sub>	Propagation delay time, high-to-low-level output		1	2.5	4	ns
t <sub>r</sub>	Output signal rise time		500	800	1200	ps
t <sub>f</sub>	Output signal fall time		500	800	1200	ps
t <sub>sk(p)</sub>	Pulse skew ( t <sub>PHL</sub> - t <sub>PLH</sub>  )			150	600	ps
t <sub>sk(o)</sub>	Output skew‡			100	400	ps
t <sub>sk(pp)</sub>	Part-to-part skew§				1	ns
t <sub>PZH</sub>	Propagation delay time, high-impedance-to-high-level output	See Figure 3		7	15	ns
t <sub>PZL</sub>	Propagation delay time, high-impedance-to-low-level output			7	15	ns
t <sub>PHZ</sub>	Propagation delay time, high-level-to-high-impedance output			7	15	ns
t <sub>PLZ</sub>	Propagation delay time, low-level-to-high-impedance output			7	15	ns

† All typical values are at 25°C and with a 3.3-V supply.

‡ t<sub>sk(o)</sub> is the magnitude of the time difference between the t<sub>PLH</sub> or t<sub>PHL</sub> of all drivers of a single device with all of their inputs connected together.

§ t<sub>sk(pp)</sub> is the magnitude of the difference in propagation delay times between any specified terminals of any two devices characterized in this data sheet when both devices operate with the same supply voltage, at the same temperature, and have the same test circuits.



## PARAMETER MEASUREMENT INFORMATION

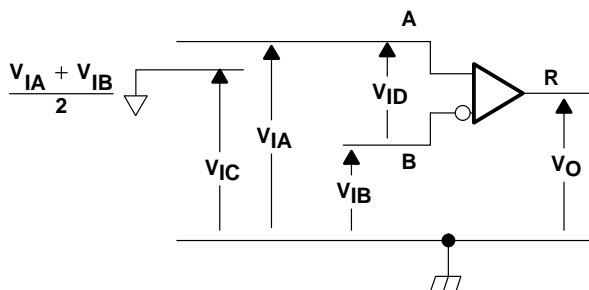


Figure 1. Voltage Definitions

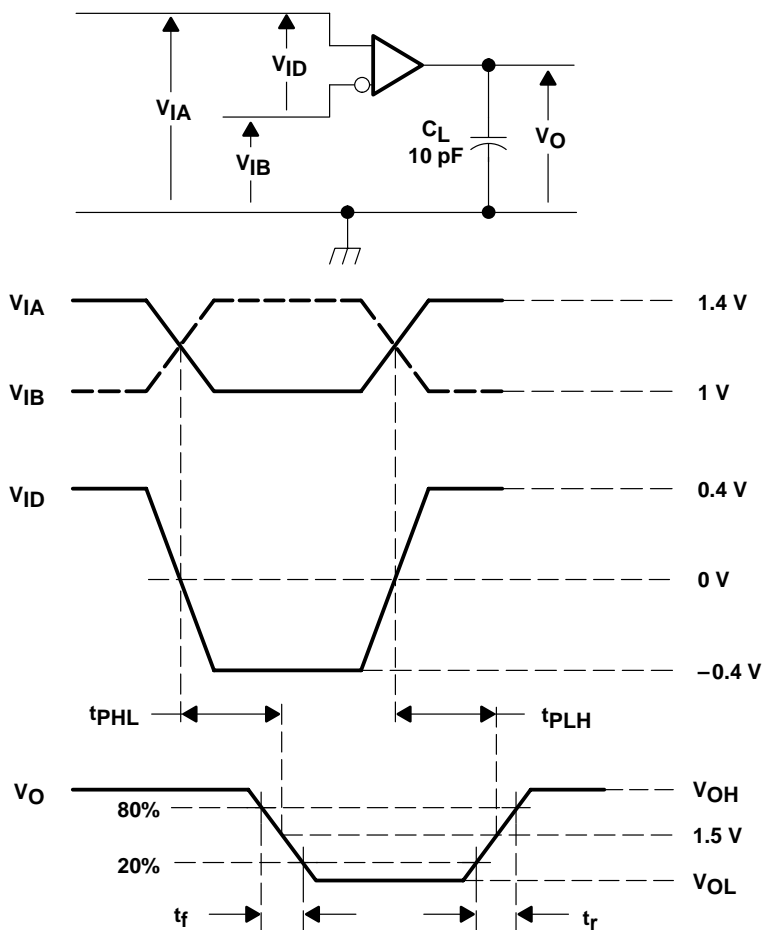
Table 1. Receiver Minimum and Maximum Input Threshold Test Voltages

APPLIED VOLTAGES		RESULTING DIFFERENTIAL INPUT VOLTAGE	RESULTING COMMON- MODE INPUT VOLTAGE
$V_{IA}$	$V_{IB}$	$V_{ID}$	$V_{IC}$
1.25 V	1.15 V	100 mV	1.2 V
1.15 V	1.25 V	-100 mV	1.2 V
2.4 V	2.3 V	100 mV	2.35 V
2.3 V	2.4 V	-100 mV	2.35 V
0.1 V	0 V	100 mV	0.05 V
0 V	0.1 V	-100 mV	0.05 V
1.5 V	0.9 V	600 mV	1.2 V
0.9 V	1.5 V	-600 mV	1.2 V
2.4 V	1.8 V	600 mV	2.1 V
1.8 V	2.4 V	-600 mV	2.1 V
0.6 V	0 V	600 mV	0.3 V
0 V	0.6 V	-600 mV	0.3 V

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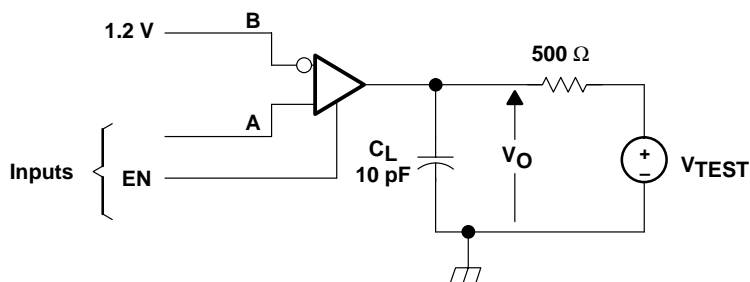
## PARAMETER MEASUREMENT INFORMATION



NOTE: All input pulses are supplied by a generator having the following characteristics:  $t_r$  or  $t_f \leq 1 \text{ ns}$ , pulse repetition rate (PRR) = 50 Mpps, pulse width =  $10 \pm 0.2 \text{ ns}$ .  $C_L$  includes instrumentation and fixture capacitance within 0,06 m of the D.U.T.

**Figure 2. Timing Test Circuit and Wave Forms**

### PARAMETER MEASUREMENT INFORMATION



NOTE A: All input pulses are supplied by a generator having the following characteristics:  $t_r$  or  $t_f \leq 1$  ns, pulse repetition rate (PRR) = 0.5 Mpps, pulse width =  $500 \pm 10$  ns.  $C_L$  includes instrumentation and fixture capacitance within 0,06 m of the D.U.T.

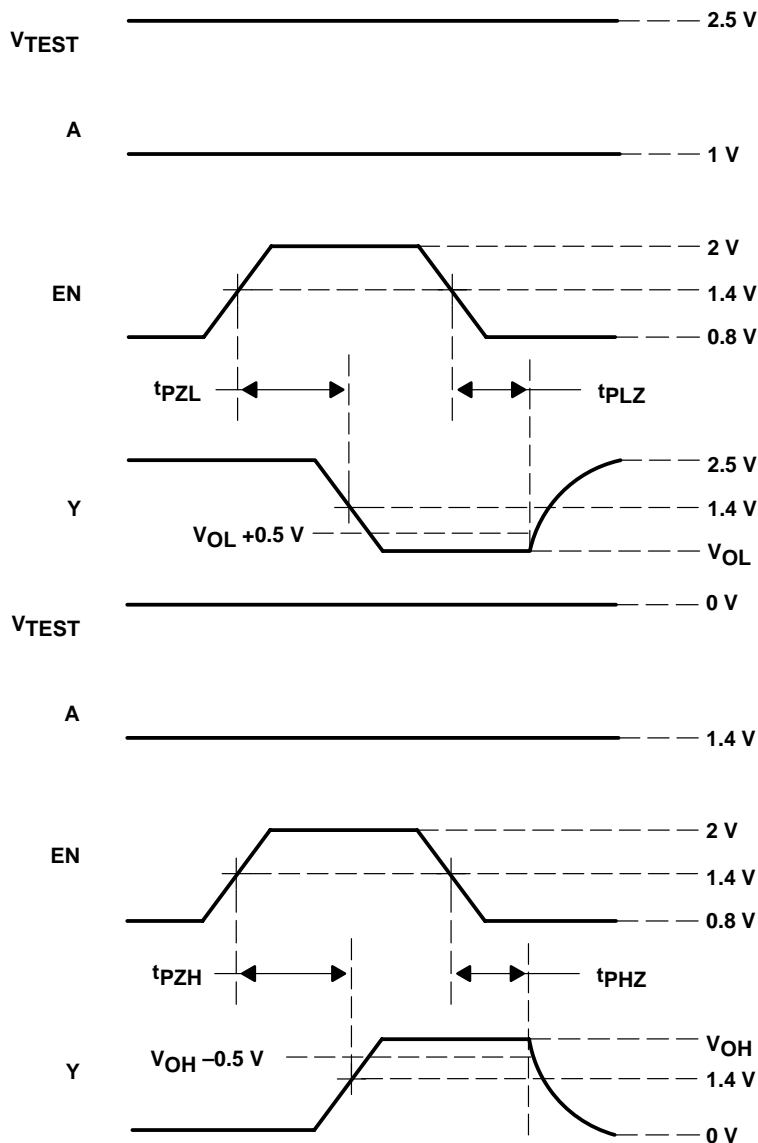


Figure 3. Enable/Disable Time Test Circuit and Wave Forms

# SN65LVDS388, SN65LVDT388, SN75LVDS388, SN75LVDT388 HIGH-SPEED DIFFERENTIAL LINE RECEIVERS

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## TYPICAL CHARACTERISTICS

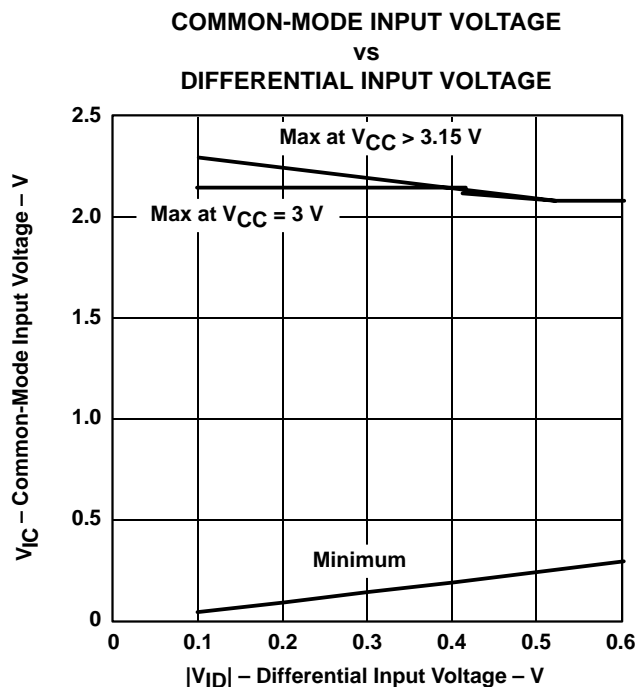


Figure 4

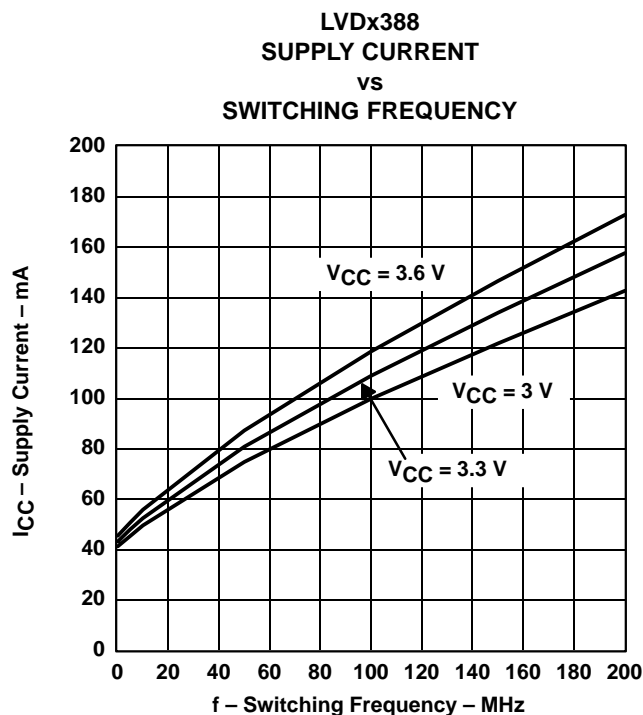


Figure 5

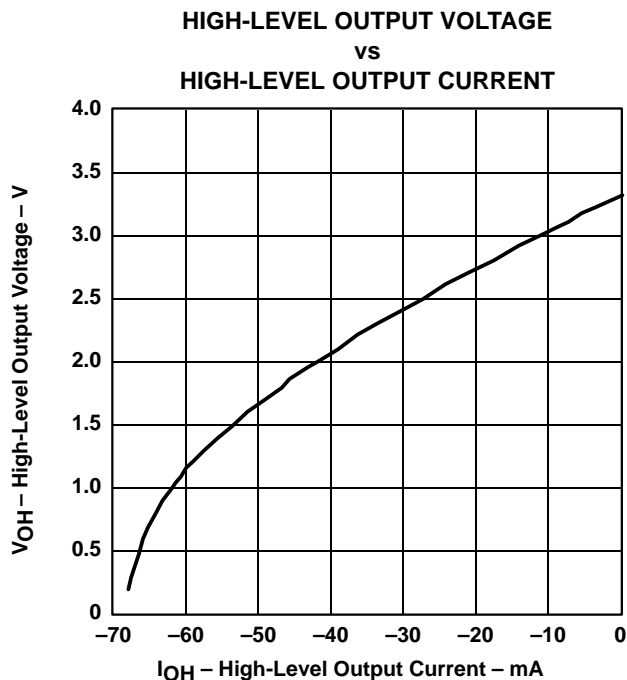


Figure 6

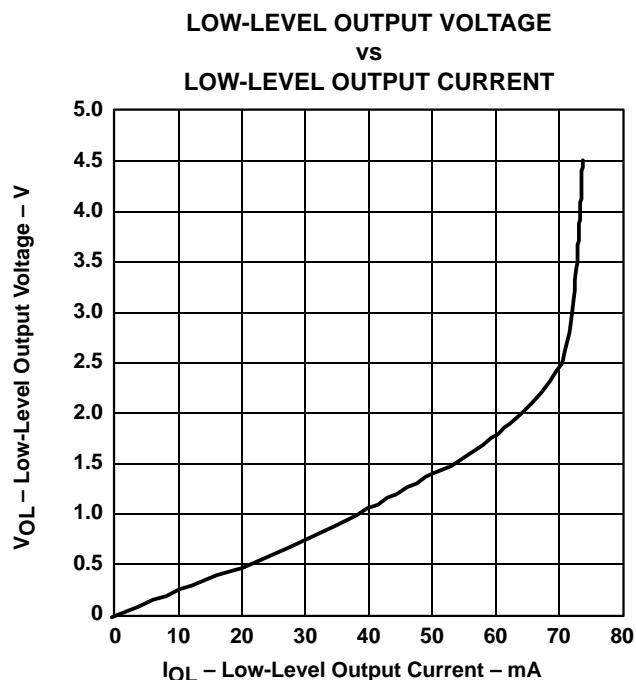


Figure 7



TYPICAL CHARACTERISTICS

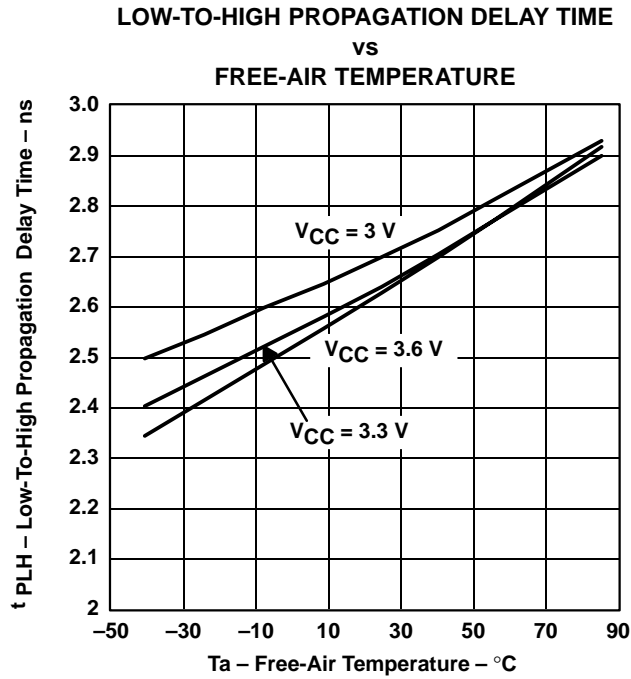


Figure 8

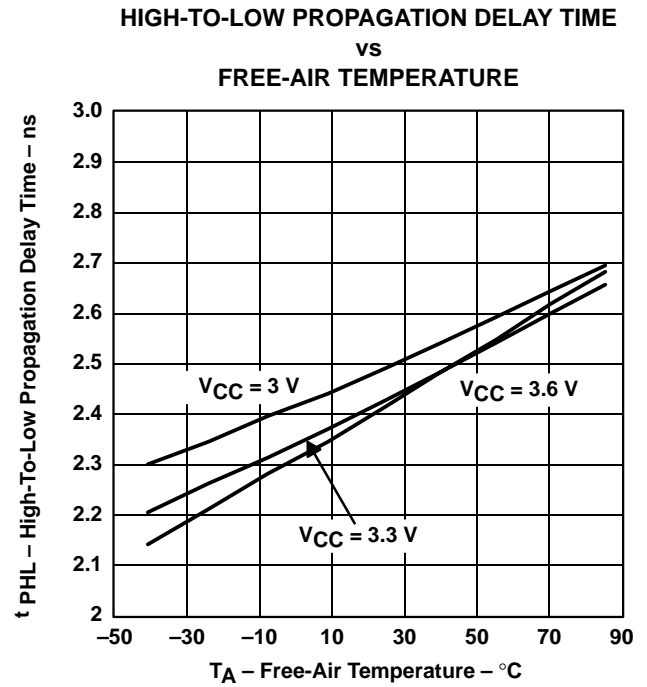


Figure 9

SN65LVDS388, SN65LVDT388, SN75LVDS388, SN75LVDT388  
HIGH-SPEED DIFFERENTIAL LINE RECEIVERS

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APPLICATION INFORMATION

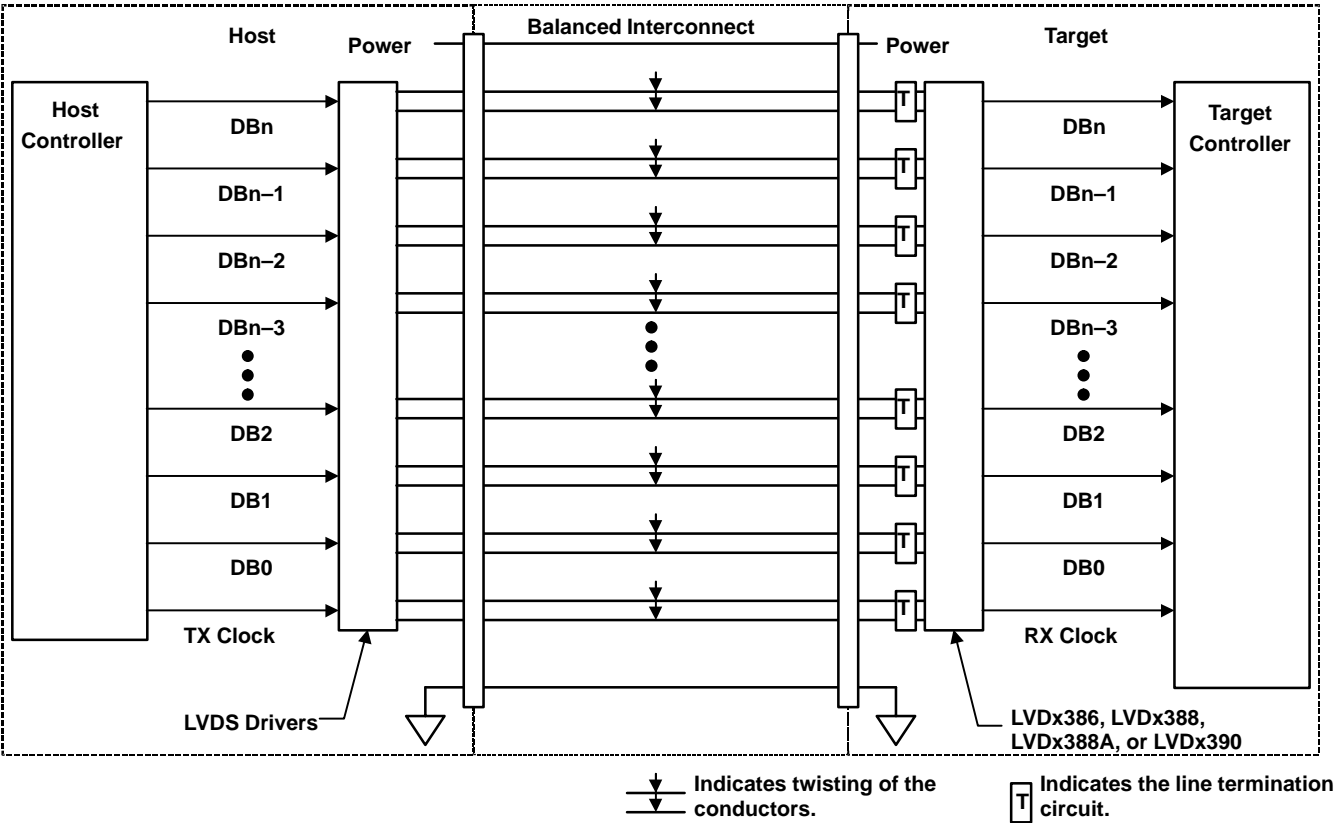


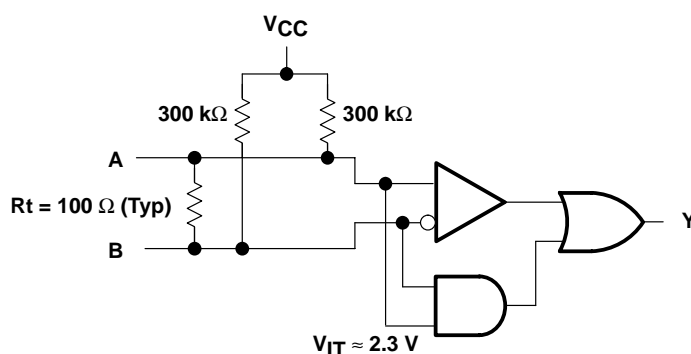
Figure 10. Typical Application Schematic

## APPLICATION INFORMATION

### fail safe

One of the most common problems with differential signaling applications is how the system responds when no differential voltage is present on the signal pair. The LVDS receiver is like most differential line receivers, in that its output logic state can be indeterminate when the differential input voltage is between  $-100\text{ mV}$  and  $100\text{ mV}$  and within its recommended input common-mode voltage range. TI's LVDS receiver is different in how it handles the open-input circuit situation, however.

Open-circuit means that there is little or no input current to the receiver from the data line itself. This could be when the driver is in a high-impedance state or the cable is disconnected. When this occurs, the LVDS receiver will pull each line of the signal pair to near  $V_{CC}$  through  $300\text{-k}\Omega$  resistors as shown in Figure 10. The fail-safe feature uses an AND gate with input voltage thresholds at about  $2.3\text{ V}$  to detect this condition and force the output to a high-level regardless of the differential input voltage.



**Figure 11. Open-Circuit Fail Safe of the LVDS Receiver**

It is only under these conditions that the output of the receiver will be valid with less than a  $100\text{-mV}$  differential input voltage magnitude. The presence of the termination resistor,  $R_t$ , does not affect the fail-safe function as long as it is connected as shown in the figure. Other termination circuits may allow a dc current to ground that could defeat the pullup currents from the receiver and the fail-safe feature.

# SN65LVDS388, SN65LVDT388, SN75LVDS388, SN75LVDT388 HIGH-SPEED DIFFERENTIAL LINE RECEIVERS

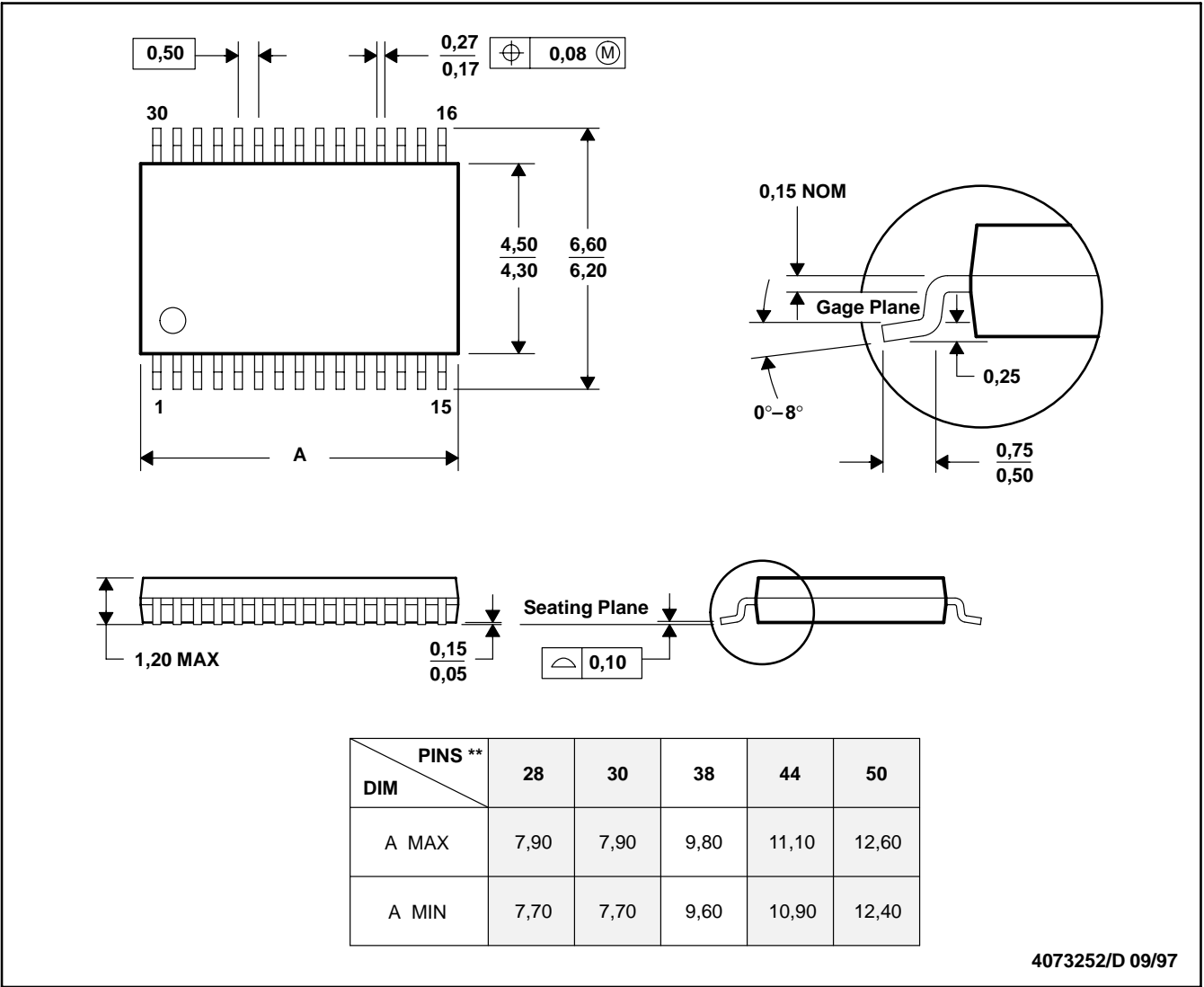
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## MECHANICAL DATA

DBT (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

30 PINS SHOWN



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion.
  - D. Falls within JEDEC MO-153

## PACKAGING INFORMATION

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
SN65LVDS388DBT	NRND	SM8	DBT	38		Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
SN65LVDS388DBTR	NRND	SM8	DBT	38		Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
SN65LVDT388DBT	OBSOLETE	SM8	DBT	38		Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
SN65LVDT388DBTG4	ACTIVE	SM8	DBT	38	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
SN65LVDT388DBTR	OBSOLETE	SM8	DBT	38		Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
SN75LVDS388DBT	NRND	SM8	DBT	38		Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
SN75LVDS388DBTR	NRND	SM8	DBT	38		Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
SN75LVDT388DBT	OBSOLETE	SM8	DBT	38		Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
SN75LVDT388DBTR	OBSOLETE	SM8	DBT	38		Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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Interface	<a href="http://interface.ti.com">interface.ti.com</a>	Digital Control	<a href="http://www.ti.com/digitalcontrol">www.ti.com/digitalcontrol</a>
Logic	<a href="http://logic.ti.com">logic.ti.com</a>	Military	<a href="http://www.ti.com/military">www.ti.com/military</a>
Power Mgmt	<a href="http://power.ti.com">power.ti.com</a>	Optical Networking	<a href="http://www.ti.com/opticalnetwork">www.ti.com/opticalnetwork</a>
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Mailing Address: Texas Instruments  
Post Office Box 655303 Dallas, Texas 75265

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